Be sure this is the latest version!

4.425

0.85

1.750

0.50

0.950

1.125

0.90

0

0

NOTE 4

0.425

0.625

0.625

1.800

2.55

3.475
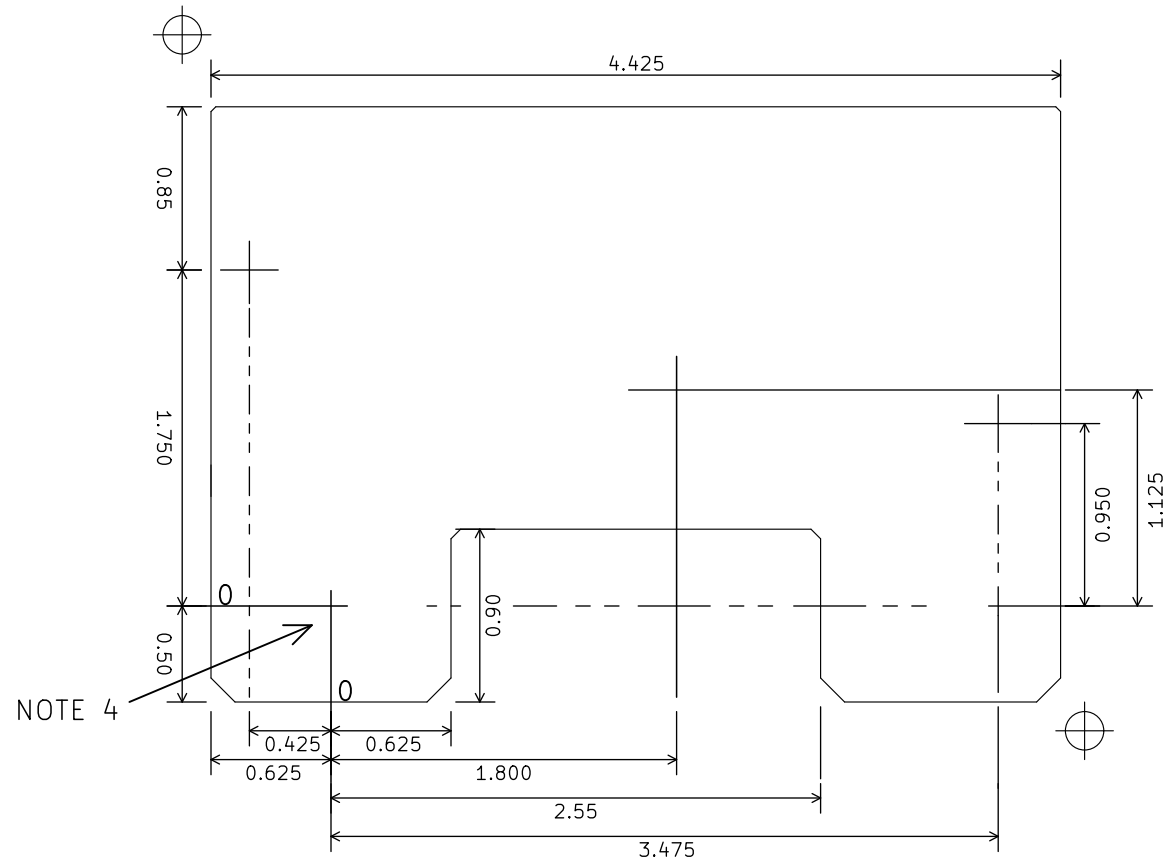
# NOTES:

1: DESCRIPTION:

.062" (nom) Etched Circuit board, not intended for lead free assembly. Min. 8/8 SMT design rules, hybrid SMT/through hole.

2: MATERIAL & FINISH:

.062" fiberglass, 2 side 1 oz finished Cu, 2-side solder mask, and 2-side silkscreen. Solder mask & silkscreen colors per 00-PCB-README file. Silkscreen and soldermask colors per 00-PCB-README file.

3. Dimensions:

Finish dimensions per drawing. +/- .005" on decimals, +/- .003" on holes, 1/64" on fractions, unless noted. Chamfer or miter corners .025" - .050", unless noted. Undimensioned items to be positioned per artwork.

4. Co-ordinate System:

Drill file and SMT centroid 0, 0 origin (reference point) located per drawing.

5. ASSEMBLY:

a: Not intended for lead-free assembly. Refer to 00-ASM-README file.
b: Orient battery holder per legend.

Project Mgr: R. Ristich
Designed: Paul Reich
Drawn: Paul Reich
*Workshop 88*

# BOARD, PC, THOTCON 0x5

File: thotcon_0x5.brd
Sheet:

| *Title: BOARD, PC, THOTKON OX5* | | |
|---|---|---|
| Size: A | *Date: 26 feb 2014* | *Rev: T1* |
| KiCad E.D.A. | | Id: 1/1 |